

Evaluation Board User Guide UG-ADIN1200

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Evaluation Board for the ADIN1200 Robust, Industrial Low Latency 10/100 Ethernet PHY

FEATURES

Single external 5V supply
FMC connector for RGMII/MII interface & Status signals
Accessible surface-mount configuration resistors & dial
switches

EVALUATION KIT CONTENTS

EV-ADIN1200FMCZ evaluation board MDIO Interface Dongle

ADDITIONAL EQUIPMENT NEEDED

Power supply to connect to EXT_5V connector or +5V barrel adaptor to connect to P4 (+5V max)
Ethernet cable
USB cable
PC running Windows 7 upward

ADIN1200 Datasheet

GENERAL DESCRIPTION

This user guide describes the evaluation board (EV-ADIN1200FMCZ), designed to allow the user to easily evaluate the key features of the ADIN1200 Industrial 10/100 Ethernet

PHY. The board is powered from an external single 5V (max) supply rail, which can be supplied either via P4 plug or EXT_5V terminal block. For additional flexibility, the board can be supplied direct from the FMC connector (node name "12V_FPGA") or from an external 12V source via "EXT_12V" terminal block. f the 12 V rail option is used, it is regulated down to +5 V on board by an ADP7105-5.

All chip supplies are regulated from the +5 V rail providing nominally:

- VDDIO = 2.5 V (configurable as 1.8 V/2.5 V/3.3 V)
 - AVDD3P3 = 3.3 V
 - DVDD= 3.3 V (non-chip supply)

An FMC connector (P3) is provided for ease of connection to a master FPGA system. P5 provides access to MDIO control. The board is also fitted with a 25MHz crystal (Y1). Complete specifications for the ADIN1200 product itself can be found in the ADIN1200 datasheet, which should be consulted in conjunction with this user guide when using the evaluation board.

EVALUATION BOARD

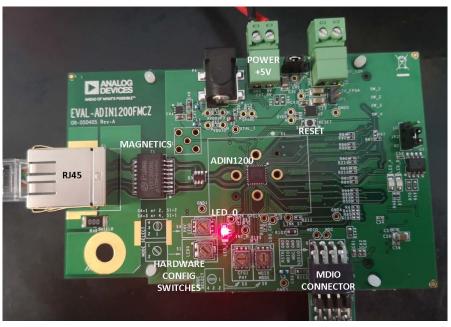


Figure 1. Overview of ADIN1200 Evaluation board

Evaluation Board User Guide

TABLE OF CONTENTS

Features1
Evaluation Kit Contents
Additional Equipment Needed1
General Description1
Evaluation Board1
Revision History2
Getting Started
Evaluation Board Hardware4
Power Supplies4
Power Sequencing4
Board Usage Options4
Jumper Options5
Clock Options5
On Board EEPROM and LEDs5
ADIN1200 LED Pin6
Mac Interface
MDIO Interface Dongle
Configuration Pins Setup8
Software Overview10
Installing the ADIN1200 software

Initial Setup11
Evaluation Software
Detailed Overview
Troubleshooting
Installation Tips
Software Tips
Hardware Tips18
Layout Guidelines
Board Stack-up
Ground Planes
Isolation Guidelines
Power Supply decoupling
MAC interface
Management Interface
Placement of the TVS
Thermal considerations
Evaluation Board Schematic and Artwork
Ordering Information
Pill of Materials

REVISION HISTORY

6/20—Revision PrE: Added Continuous Frame Generator mode. Added ability to load scripts.

4/19—Revision PrA: Initial Version

GETTING STARTED QUICK START STEPS

To set up the EV-ADIN1200FMCZ and use with the Analog Devices GUI, take the following steps:

- 1. Connect +5V power to the ADIN1200 board via the EXT_5V or the barrel connector
- Connect USB cable to the MDIO interface dongle.
 Connect USB cable to PC. When connecting the MDIO interface dongle to PC for the first time, drivers will automatically be installed. Wait until the driver install is complete before proceeding to the next step.
- Connect the MDIO interface dongle to the ADIN1200 board, ensuring the ADuCM3029 Microcontroller faces up, see Figure 5. The MDIO interface dongle is keyed and can only be connected one way.
- 4. Launch the ADIN1200 software from the Analog Devices folder in the start menu.
- 5. Connect Ethernet cable to the RJ-45 connector and to another PHY device.

EVALUATION BOARD HARDWARE

POWER SUPPLIES

The ADIN1200 board operates from a single external supply rail. It can be powered from either +5 V or +12 V as follows. When supplying the board with +5 V, user has option to apply +5 V via P4 or to the connector EXT_5V, with JP3 configured for 5V/ $^{\prime}$ A.

Alternatively, the board can be powered from an FMC-supplied +12V supply in which case JP1 should be removed and JP3 set to position 12V/'B'. A final option is to use an external +12 V applied to the EXT_12V connector and JP3 configured for 12V/'B', in this case the on-board ADP7105 generates the required +5 V power for the board. Figure 2 shows an overview of the power supply configuration on the board.

From the +5 V "SUPPLY", the rest of the board power requirements are generated. Two ADP223 devices generate the various power rails, AVDD3P3, VDDIO and DVDD, the default nominal voltages are listed in Table 1. The ADIN1200 only requires AVDD3P3 & VDDIO.

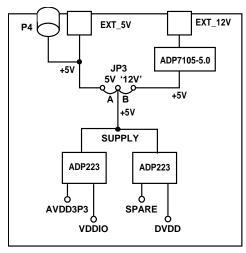


Figure 2. Overview of Power Supplies

The VDDIO voltage rail defaults to 2.5 V with the installed components, it may be adjusted if other VDDIO voltages are required by changing the value of R12 accordingly as detailed in Table 1.

Table 1. Default Power Supply Configuration

Supply Rail	Nominal Voltage	Adjustment			
AVDD3P3	3.3V	N/A			
VDDIO	2.5V 1.8 V with R16 = $130k\Omega$				
		2.5 V with R16= 200kΩ			
		$3.3 \text{ V with R16} = 280 \text{k}\Omega$			
DVDD	3.3V	N/A			

Table 2 gives an overview of the board current for various operating modes.

Table 2. Board Quiescent Current (EXT $_5V = +5V$)

Board Status	Typical Quiescent Current
On power-up	30 mA initially
	6.5 mA in EDPD
While in Hardware Power Down (RESET_N held low)	6.5 mA
10BASE-TX	50 mA
100BASE-TX	60 mA

POWER SEQUENCING

There are no power sequencing requirements with the ADIN1200 device. The board is powered from one voltage rail applied to the board, 5V or 12V as described above.

When using the ADIN1200 evaluation board with the MDIO interface dongle, there is currently a known sequence requirement for the MDIO interface dongle, this may be resolved later via software. Ideally the MDIO interface dongle should be powered from the USB cable prior to connection to ADIN1200 board. Alternatively if issues are observed simply restart the GUI to resolve any board connection issues.

BOARD USAGE OPTIONS

The board can be used in 2 general modes. In standalone mode, the board can be used to evaluate the ADIN1200 in IEEE 802.3 test modes, establish links with a link partner and evaluate the performance of the chip. In this mode the board should be powered with 5 V at the EXT_5V connector.

The second mode is to plug the board into an FPGA development board which provides an FMC LPC connector. In this mode, the MII interfaces, clocks and LEDs can be connected to an FPGA where the MAC and upper layers can be implemented for evaluation of the ADIN1200 in a full system. In this case, an external 12 V supply at the EXT+12V connector is preferable, but the FPGA option can also be used.

JUMPER OPTIONS

A minimal number of jumpers on the evaluation board must be set for the required operating setup before using the board. The functions of these jumper options are described in Table 4. The default setup is highlighted in Table 3.

Table 3. Default Link Options

1 · · · · · · · · · · · · · · · · · · ·			
Link No.	Position	Function	
JP1	Not inserted	Default connection is to EXT_5V	
JP2	B ("HI")	This link selects high or low for the WP of U7.	
JP3	A ("5V")	This link connects EXT_5V to the regulators.	

Table 4. Jumper Functions

Jumper	
No.	Function
JP1	This jumper sets the 12 V supply source for the ADP7105 which provides a +5 V rail for other onboard circuit needs. The ADP7105 is powered from a 12 V rail which can originate from the 12V_FPGA supply rail if an FPGA is connected to the FMC connector, JP1 can be left open in this case. Alternatively an external +12 V rail can be applied to the EXT_12V connector and used to power the ADP7105, in this case, insert JP1.
JP2	JP2 sets the write mode of the AT24C02D-SSHM-T EEPROM (U7). Position A ("LO") — Enable writing to the EEPROM. Position B ("HI") — Write protect the EEPROM (default).
JP3	This sets the 5 V supply source "SUPPLY". Position A ("5V") — P2 or EXT_5V are the supply source (default). Position B ("12V") — FPGA via the FMC connector or EXT_12V is 12 V supply source.

CLOCK OPTIONS

The evaluation board provides options to supply the ADIN1200 clock requirements from an on-board crystal oscillator or alternatively from an external clock applied to J1.

There are a number of crystal oscillators on the ADIN1200 evaluation board and MDIO interface dongle

- Y1 is a 25 MHz crystal connected across the ADIN1200 XTAL_I/XTAL_O pins.
- Y2 is a 32.678 kHz crystal used on the MDIO board for the ADuCM3029
- Y3 is a 26 MHz crystal used on the MDIO board for the ADuCM3029

R120 must be populated and R15 removed if the signal applied to J1 is to be used by the ADIN1200. See Component

Recommendations section in the Datasheet for more information.

ON BOARD EEPROM AND LEDS

Also found on the evaluation board are two FPGA controllable LEDs and 1 un-programmed I2C EEPROM.

The AT24C02D-SSHM-T (U7) can be programmed with voltage settings so that the FPGA provides the correct voltages on its supply rails. The write address of the EEPROM is $0b[10100\ [GA1]\ [GA0]\ 0]$ and the read address is $0b[10100\ [GA1]\ [GA0]\ 1]$.

ADIN1200 LED PIN

There is one LED pin on the ADIN1200. The LED pin can be configured in various operating modes using the MDIO interface dongle –full details are available in the Register map of the ADIN1200 Datasheet. By default LED_0 is on when a link is established and it blinks when there is activity.

The LED_0 pin is also shared with the PHY_CFG0 Pin Configuration function and it may therefore be necessary that the voltage level on the pin be at a certain value on power on and reset in order to configure the ADIN1200 as required. See STATUS LED section of ADIN1200 datasheet for further details.

The ADIN1200 evaluation board is configured for Mode 3 & 4 by default. If user wishes for PHY_CFG0 to be used in Mode 1 or 2 (Switch S4), user should also change S1 accordingly.

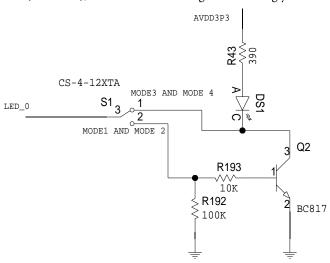


Figure 3. LED0 Configuration

MAC INTERFACE

The MDIO interface dongle can be accessed directly through the P5 connector for users wishing to connect their own MAC interface with the PHY.

Alternatively, included in the evaluation kit is an MDIO interface dongle for interfacing with the ADIN1200 evaluation board via the ADI evaluation GUI running on the PC.

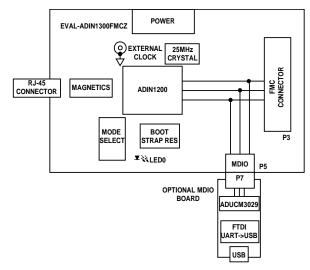


Figure 4. Simplified overview of ADIN1200 board with MDIO board connected

MDIO INTERFACE DONGLE

This board contains an ADuCM3029 microcontroller and FT232 UART to USB interface. The schematic is shown in Figure 37.

If using the MDIO interface dongle, ensure to first connect the USB cable to the board, then connect the board to the ADIN1200 board with the ADuCM3029 facing up.



Figure 5. Connection of MDIO Interface Dongle to ADIN1200 hardware

There are two LEDs on this board, DS7 and DS8. When the powered USB cable is initially connected to the MDIO interface dongle, the diode DS8 will light. When the GUI establishes communication with the board, both DS7 and DS8 will flash and continue to flash while the GUI is active and the board is selected as the local board within the GUI.

The MDIO interface dongle has two push-buttons on the underside of the board, S5 and S6 as shown in Figure 6.

- S5 is for Download/Reboot purposes
- S6 is to reset the ADuCM3029.

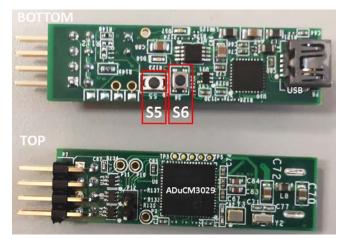


Figure 6. Overview of MDIO Interface Dongle

CONFIGURATION PINS SETUP

The board is configured as detailed in Table 5. ADIN1200 configuration settings can be changed by manipulating the resistors listed in the right-hand column. The "Configuration Pins" section of the ADIN1200 datasheet details all available options. Figure 7 highlights the location of the resistors on the underside of the PCB. The speed configuration is configured via 2 rotary switches S3 and S4, the MDIX mode is controlled using S9. Table 5 highlights the different configurations available.

Table 5. Configuration Settings

Configuration Option	Relevant Pins	Resistor Settings
PHY Address = 0b00000	RXD_3/PHYAD_3	R22, R29, R31, R37 = DNI
	RXD_2/PHYAD_2	R23, R30, R32, R38 = DNI
	RXD_1/PHYAD_1	Using internal pull-down resistors.
	RXD_0/PHYAD_0	
MDIX configuration = Auto MDIX	GP_CLK/RX_ER/MDIX_MODE	S9 position Mode
		1 Mode 1, Manual MDI
		2 Mode 2, Manual MDIX
		3 Mode 3, Auto MDIX – Prefer MDIX
		4 Mode 4, Auto MDIX – Prefer MDI (default)
		(Boards shipped in pairs will have one set to '3' and other set to '4')
PHY Configuration	LINK_ST/PHY_CFG1	Controlled by Switches S3 and S4 to provide the
 Downspeed, EDPD, EEE, 	LED_0/COUT/TX_ER/PHY_CFG0	various configuration options as documented in
Software powerdown, Forced		ADIN1200 datasheet Table 10.
speed		Default configuration
		PHY_CFG1/S3 = 1, PHY_CFG0 (S4) = 4
MAC Interface Selection	RX_CTL/RX_DV/CRS_DV/MACIF_SEL1	R8, R9 = DNI
	RXC/RX_CLK/MACIF_SEL0	R27, R28, = DNI
		Using internal pull-down resistors => MAC interface default selection = RGMII RXC/TXC 2ns delay

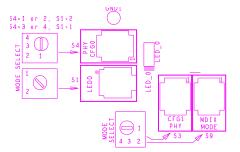


Figure 7. Mode Switch configurations

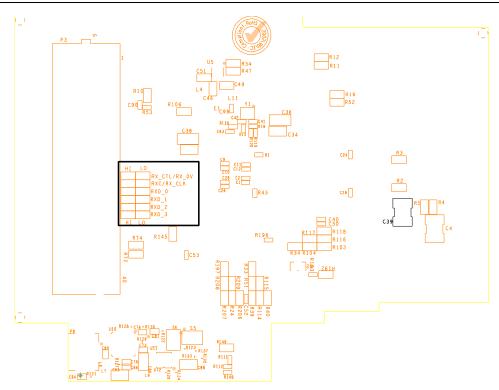


Figure 8. Configuration Resistor Placement – underside of PCB.

Evaluation Board User Guide

SOFTWARE OVERVIEW

INSTALLING THE ADIN1200 SOFTWARE

The EV-ADIN1200FMCZ evaluation kit requires software to be installed on your PC before you begin using the evaluation board. The installation installs the ADIN1200 GUI and associated documentation (datasheet and user guide).

The MDIO interface dongle uses an FTDI chip for UART to USB communication, it requires installation of drivers for the FTDI chip. These drivers are available at:

www.ftdichip.com/Drivers/CDM/CDM21228 Setup.zip

The evaluation board software must be installed before connecting the evaluation board to the USB port of the PC to ensure that the evaluation system is correctly recognized when it is connected to the PC.

The default location for installation of the software is C\Analog Devices folder.

Evaluation board Software GUI installation

To install the evaluation board software,

- 1. Launch the installer file to begin the evaluation board software installation.
- 2. A dialog box may appear asking for permission to allow the program to make changes to your computer. Click **Yes**.
- 3. The software install will pop up a welcome screen, click Next

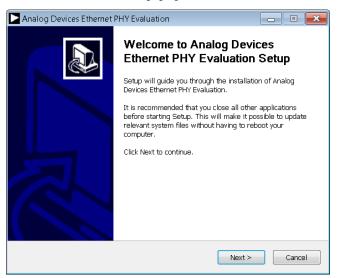


Figure 9. Installation process

4. The software will launch with overview of what is being installed and recommendations in terms of hardware power up, read and click **Next**

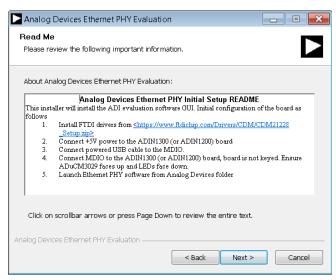


Figure 10. Installation process

5. A license agreement appears. Read the agreement, and then select **I Agree** to allow the installation to proceed.



Figure 11. Evaluation Board Software Installation: Accepting the License Agreement

Select the location to install the software, and then click Install.

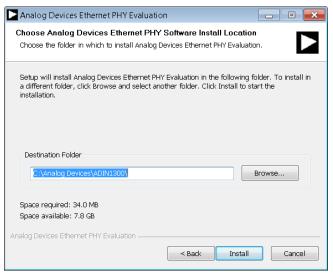


Figure 12. Installation location

A dialog box informs you when the installation is complete, click **Finish** to continue.



Figure 13. Installation complete

8. The software is installed into the Analog Devices folder on your machine. The software can be accessed via windows explorer via C:\Analog Devices\ADIN1200 Evaluation Software or alternatively through the start menu.

INITIAL SETUP

To set up the EV-ADIN1200FMCZ and use with the Analog Devices GUI, take the following steps:

- 1. Connect +5V power to the ADIN1200 board via the EXT_5V or the barrel connector
- Connect USB cable to the MDIO interface dongle.
 Connect USB cable to PC. When connecting the board to PC for the first time, drivers will automatically be installed. Wait until the driver install is complete before proceeding to the next step.
- 3. Connect the MDIO interface dongle to the ADIN1200 board, ensuring the ADuCM3029 Microcontroller faces up, see Figure 5.
- 4. Launch the ADIN1200 software from the Analog Devices folder in the start menu.

EVALUATION SOFTWARE

When the software is launched, the following GUI panel will open.

The main areas of the GUI are as follows:

- 1. Board display showing connected evaluation hardware
- 2. User buttons
- 3. Link Properties tab
- 4. Register Access tab
- 5. Clock Pin Control
- 6. Loopback
- 7. Test Modes
- 8. Frame Checker
- 9. Cable Diagnostics
- 10. Board information/linking status
- 11. Activity log information

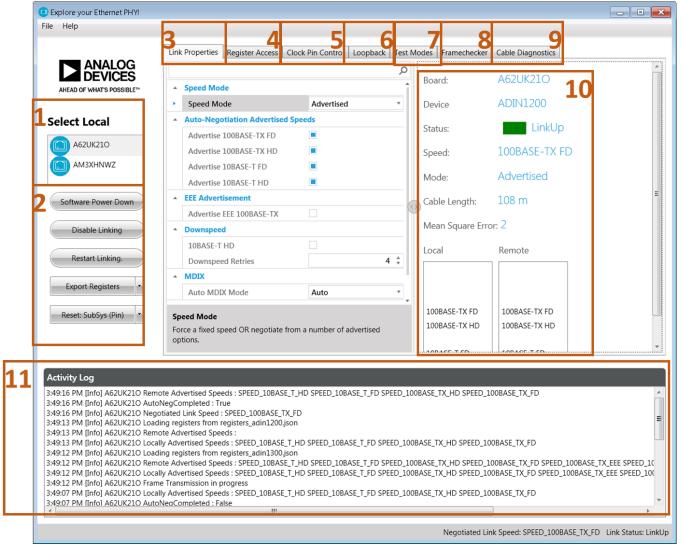


Figure 14. Main GUI Panel

DETAILED OVERVIEW

Board display showing connected EV-ADIN1200FMCZ hardware.

In the "Select Local" field, a unique hardware identifier is shown for each MDIO interface dongle connected to the PC. In the example shown in Figure 14, there are two MDIO interface dongles connected to the same PC.

The user can choose which device is addressed as the Local in this field, by clicking on the appropriate board identifier, it will be highlighted when selected. When selected, all register control, displayed Link Properties and local board information in other sections of the GUI apply to the selected board.



Figure 15. Select which MDIO Interface Dongle is being addressed

User buttons

These buttons allow user to control basic operation of the GUI and device.



Figure 16. Basic user buttons

- 1. Software power down/Up: Allows user to put the device into software power down mode where the analog and digital circuits are placed into low power state, most clocks are gated off and no link will be brought up. Click the button to enable software power down, the button will change to orange color, click again to exit from software power down and restart linking. When software power down is asserted, the other buttons for the selected device are greyed out and disabled.
- 2. **Disable/Enable Linking:** If a link is up and user wishes to disable linking, click this button.
- Restart Linking: If user has changed software configuration and wishes to restart linking process with a

- new configuration, click this button. If Link has already been established, the link will first be brought down, then restarted.
- 4. **Export Registers:** Click this button to do a data dump to the "Activity log" field. From there the register dump can be saved to text format for later offline review. Right click and "Save as" to save to a log file.



Figure 17. Activity log – displaying export registers

Reset: This dropdown allows user to initiate different types of resets

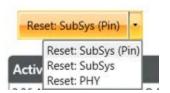


Figure 18. Reset Options

- Sub-System Software Reset with Pin Configuration
 - i. "SubSys (Pin)" reset performs a reset of the Sub-system with the Sub-system requesting a new set of hardware configuration pin settings from the chip during the software reset sequence.
 - ii. GeSftRst = 1, GESftRstCfgEn = 1
- b. Sub-System Software Reset:
 - i. "SubSys" reset performs a reset of the Sub-system with the Sub-system requesting previously stored hardware configuration pin settings to be reloaded during the software reset sequence.
 - ii. GeSftRst = 1, GESftRstCfgEn = 0
- c. PHY Core Software Reset:
 - "PHY" reset: SftRst bit resets the PHY core registers.

Link Properties tab

The Link Properties tab gives user access to the main linking configurations within the device. This window has a slider to access all the controls. When a control is selected, the GUI will provide a prompt describing the function at the bottom of the linking control box.

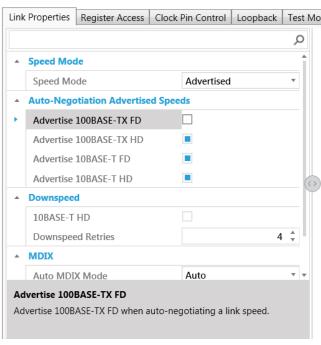


Figure 19. Link Properties Control

Speed Mode: For the selected device, user can choose to select from Advertised or Forced. This choice prepopulates the remaining user controls for the Link Properties tab as follows:

1. Advertised:

- a. Auto-Negotiated Advertised Speeds: Checkbox availability of all Auto-Negotiated Advertised speeds available. User can select/deselect as required. All speed options are available here. Default advertised will reflect Hardware configuration pins.
- b. EEE Advertisement: Checkbox to allow user advertise Energy Efficient Ethernet (EEE) as a speed option for 100BASE-TX.
- c. Downspeed: Checkbox to allow user enable Downspeed which allows the PHY to change down to a lower speed after a number of attempts to bring up a link at the highest advertised speed.
 - Downspeed Retries sets the number of time the PHY will attempt to bring up a link. Default is 4.
- d. MDIX: Dropdown box to choose between Auto MDIX, FixedMDI or FixedMDIX
- e. Energy Detect PowerDown Mode: dropdown to choose between disabled, enabled or EnabledWithPeriodicPulseTx
- 2. **Forced**: Subset of control available in Forced mode
 - a. Forced Speeds: Dropdown box to choose the required speed

- MDIX: Dropdown box to choose between Auto, FixedMDI or FixedMDIX
- c. Energy Detect Powerdown Mode:
 Dropdown to choose between disabled,
 enabled or EnabledWithPeriodicPulseTx

Register Access tab

The 'Browse" tab in the Register Access field allows user to review the bank of registers and edit register fields or bit fields as required.

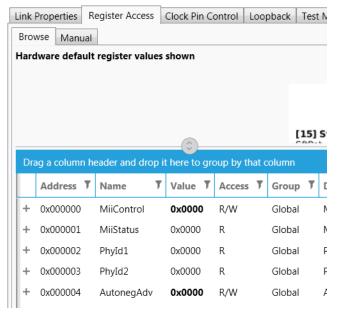


Figure 20. Register Access – full register map

The "Manual" tab enables user to perform basic reads from and write to individual registers in the ADIN1300.

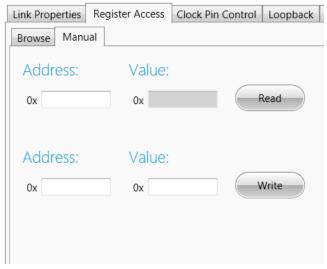


Figure 21. Register Access

The direct register read/write access can also be accessed from the right of the Activity log panel, just slide the arrow over to the left to expose it.



Figure 22. Register Access

Clock Pin Control

This section provides user ability to control what clock is applied to the GP_CLK pin.

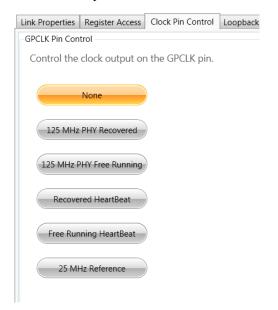


Figure 23. Clock Pin Control

Loopback

The various loopback modes are available in this tab. Consult the datasheet for full description of each loopback mode.

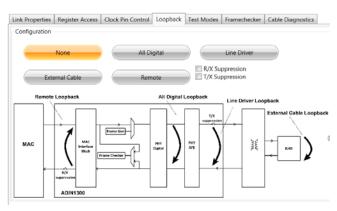


Figure 24. Loopback Modes

Testmodes

The Test Modes tab allows user initiate the various test mode functions in the device. Select the appropriate test mode and click the 'Execute Test' button.

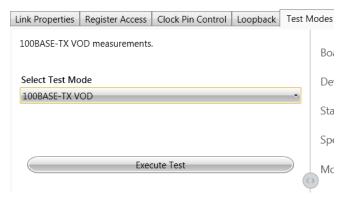


Figure 25. Testmodes

Framechecker

The Framechecker tab provides access to the frame generator & frame checker features of the ADIN1300.

The user can control the number of frames generated by the generator, the frame length and the content of the frame. The user has option to have the frame generator run in burst mode or run continuously. When running continuously, the Terminate button allows user to halt frame generation.

The Loopback button allows user to enable the remote device to loopback the data to the local device. Ensure to select the appropriate device, e.g. decide which of the connected boards is the local, configure that to generate frames, then configure the other devices in remote loopback.

The checker information displayed on the screen accumulates the number of frames sent and shows the number of errors observed.

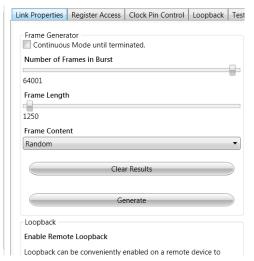


Figure 26. Overview of Frame Generation/Checker

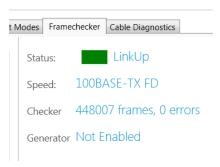


Figure 27. Display of Frame Generator status and Frame Checker result

Cable Diagnostics

The cable diagnostic feature allows user to diagnose issues with the link. There are various features within the device, some that are available when the Link is up and quantify the quality of the link, e.g. MSE level and estimated cable length. These are displayed on the main Link Properties tab.

The features contained in the Cable diagnostic tab are the ones that can be run when the link is disabled such as checking for shorts, opens and identifying the distance to the first fault. The LinkEn bit must be clear to run these checks, there

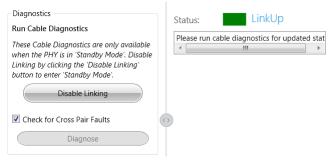


Figure 28. Cable diagnostics Configuration, when Link is up

Click the disable linking button to set LinkEn =0 to allow diagnostics to be run.

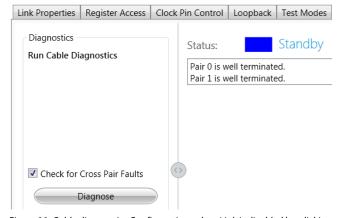


Figure 29. Cable diagnostics Configuration, when Link is disabled by clicking "Disable Linking" button, with a cable connected to a remote PHY

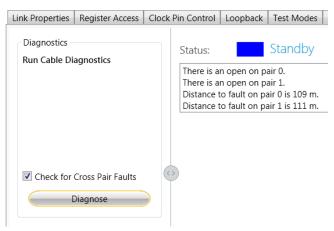


Figure 30. Cable diagnostics Configuration, when Cable is open

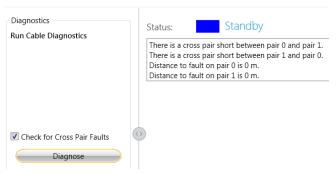


Figure 31. Cable diagnostics Configuration, when Cable is crossed

Board information/linking status

This section displays the current status of the selected PHY chip (as determined in the "Select local" section), including whether a link is established, the speed of the link and the speed mode. The local and remote fields show the advertised speeds that are available in the local device (the selected device/board) and also what the remote PHY is returning.

If the user switches between two boards in "Select local" section, the information shown in these fields will be updated to reflect the information provided from the board defined as local.



Figure 32. Board status information

The LED shows the status of the selected PHY, depending on how the user has the device configured.



Figure 33. Status LED

Activity log information

The activity log reports status information and register writes issues to the selected board. It captures the activity in the GUI corresponding to user button presses and information on whether a link is established.

The board ID is recorded with each bit field change, so it is clear which device is being addressed.

```
Activity Log

2:50:36 PM [Info] AL2YSWGN disable Auto-Negotiation
2:50:36 PM [VerboseInfo] AL2YSWGN BitField "AutonegEn" = 0
2:50:35 PM [Info] AL2YSWGN Locally Advertised Speeds : SPEED_
2:50:25 PM [Info] A62UK210 Locally Advertised Speeds : SPEED_
2:50:28 PM [VerboseInfo] A62UK210 BitField "Fd100Adv" = 0
2:50:21 PM [Info] A62UK210 Remote Advertised Speeds : SPEED_
2:50:21 PM [Info] A62UK210 AutoNegCompleted : True
2:50:19 PM [Info] A62UK210 Remote Advertised Speeds : SPEED_
2:50:18 PM [Info] A62UK210 chinking Enabled : True
2:50:16 PM [Info] A62UK210 enable Linking
2:50:16 PM [VerboseInfo] A62UK210 BitField "LinkEn" = 1
```

Figure 34. Board status information

The activity log can be cleared by right-clicking and selecting "Clear". The contents of the activity field can be exported for offline review by right-clicking and choosing "Save as". The file saved is a text file, with default location in the Analog Devices ->ADIN1200 folder.

Loading a script file

The GUI allows user to load a sequence of register commands from a file. The file is located in the ADIN1300 folder and called "registers_scripts.json"

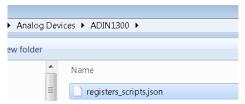


Figure 35. Location of the script file

The register commands can be loaded with either the register name or the register address as shown in the simple examples in the file. The commands are loaded sequentially, so create the sequence of write commands using a text editor, ensure to copy the exact syntax and match the register names with that in the datasheet (otherwise errors will be reported in the activity log). Give your script a unique and meaningful name. Example shown below for "SftPd Down&Up" routine.

```
"Name": "SftPd Down&Up",

"RegisterAccesses": [

{

"MemoryMap" : "GEPhy",

"RegisterName": "SftPd",

"Value": 1

},

{

"MemoryMap" : "GEPhy",

"RegisterName": "SftPd",

"Value": 0

},

]
```

Within the GUI window, there are two dropdown options under the Activity log where the script file can be selected and which section of the script to run. Click the button to load selected script.



Figure 36. Script load – dropdown buttons

Evaluation Board User Guide

TROUBLESHOOTING

INSTALLATION TIPS

- Always allow the installation to fully complete (the software is a two part installation: the ADI package installer (GUI and documentation) and the FTDI drivers which can be found at www.ftdichip.com/Drivers/CDM/CDM21228_Setup.zip).
 The installation may require a restart of the PC.
- When you first plug in the MDIO interface dongle via the USB cable, allow the New Found Hardware Wizard to run completely. Though this may take some time, it is required prior to starting the software.
- Where the board does not appear to be functioning, ensure the following:
 - Power is applied to the ADIN1200 evaluation board
 - Powered USB connector is applied to the MDIO interface dongle.
 - Both boards are connected together.
 - o Ethernet cables connected
 - o Launch software

SOFTWARE TIPS

If the software does not read any data back, observe if there are any messages in the Activity log. There is one known communication bug in the connection of the MDIO interface dongle and ADIN1200 evaluation board as discussed below:

MDIO Board communications – Known Issue

A known behavior when using the MDIO interface dongle with the ADIN1200 board is related to how the boards are powered/connected together. If user connects MDIO interface dongle to ADIN1200 board before connecting USB power to dongle AND user has GUI open, there is a possibility the GUI may not properly establish communications with the MDIO board

The GUI polls for the MDIO interface dongle regularly and if an error in MDIO communications is found, it will be flagged in the activity log and highlighted in red font, see Figure 32. The message will also include prompt how to resolve the issue. In this example, user is advised to reset the MDIO interface dongle through Button S6. There are two buttons on the underside of the MDIO interface dongle, identify S6 and reset. This will restart the MDIO interface dongle. If S6 restart does not resolve communications, exit the GUI and re-launch.

Future software revisions will look to resolve.

Activity Log 10:18:08 AM [Error] Dongle firmware response is corrupted. Try resetting it via Button S6. 10:18:03 AM [Error] Dongle firmware response is corrupted. Try resetting it via Button S6. 10:17:59 AM [Error] Dongle firmware response is corrupted. Try resetting it via Button S6. 10:17:53 AM [Info] AL2YSWGN PHY NOT in Software Power Down

Figure 37. Example Activity log when MDIO board is not responding

HARDWARE TIPS

Check that power is applied to the both boards as discussed above. Measure the voltage at various points on the ADIN1200 board using the Test points (DVDD, 5V, AVDD3P3, VDDIO) Crosscheck the voltages versus the detail in Table 1.

No Link established

- Check the cables are connected correctly to the RJ-45 connector and between boards or PHY pairs.
- Where using two ADIN1200 boards, check both boards are powered.
- Check the Hardware configuration is appropriate for required linking arrangement
 - If changes have been made to PHY_CFG0/1switch configuration, review corresponding LED0 arrangement for MODEx operation.

LEDO not blinking, but Link Established reported in GUI

By default LED_0 is on when a link is established and it blinks when there is activity. The ADIN1200 evaluation board is configured for Mode 3 & 4 by default, with R191 and R192 resistors populated. If user wishes for PHY_CFG0 to be used in Mode 1 or 2, remove R191 and R192 and insert R110. If changes have been made to PHY_CFG0/1 switch configuration, review corresponding LED0 arrangement for MODEx operation.

LAYOUT GUIDELINES

BOARD STACK-UP

The evaluation board consists of a four layer board. Top Layer, Layer 2, Layer 3 and Bottom Layer. All layers have a copper pour, with exception being around sensitive traces for the MAC and MDI interfaces.

GROUND PLANES

The top and bottom layers carry mainly signal and routing from the ADIN1200. The two inner layers are used for ground planes. Layer 2 is a full ground plane. Layer 3 contains primarily ground with area dedicated to DVDD and VDDIO power planes. While the ADIN1200 is a mixed signal device, there is just one type of ground return, GND.

ISOLATION GUIDELINES

Transformer layout

There should be no metal layers directly underneath the transformer to minimize any noise coupling across the transformer.

RJ-45 layout

For good EMC performance, it is recommended to use a metal shielded RJ-45 connector with the shield connected to chassis ground. There should be an isolation gap between the chassis ground and the IC GND with consistent isolation across all layers.

POWER SUPPLY DECOUPLING

From a PCB layout point of view, it is very important to locate the decoupling capacitors as close as possible to the power and GND pins to minimize the inductance.

MAC INTERFACE

When routing the TX/RX traces, ensure to match the lengths of the pairs. Avoid crossover of the signals where possible. Stubs should be avoided on all signal traces. It is recommended to route traces on the same layer.

MANAGEMENT INTERFACE

MDI interface

Traces running from the MDI_[x]_P/N pins of the ADIN1200 to the Magnetics must be on the same side of the board (no

vias), kept as short as possible (less than 1" in length) and individual trace impedance of these tracks kept below 50 Ω , with differential impedance of 100 Ω for each pair. The same recommendations apply for traces running from the magnetics to the RJ45 connector.

Impedance should be kept constant throughout as any discontinuities could impact signal integrity.

Each pair must be routed together, trace widths the same throughout, trace lengths should be kept equal where possible and avoid any right angles on these traces (use curves in traces or 45° angles). Stubs should be avoided on all signal traces. It is recommended to route traces on the same layer.

PLACEMENT OF THE TVS

It is recommended to place the TVS close to the ADIN1200 device, to ensure minimal track inductance between the external protection and internal protection within the device.

THERMAL CONSIDERATIONS

The ADIN1200 is packaged in an LFCSP package. This package is designed with an exposed paddle which must be soldered to the PCB for mechanical and thermal reasons. The exposed paddle acts to conduct heat away from the package and into the PCB. By incorporating an array of thermal vias in the PCB thermal paddle, heat is dissipated more effectively into the inner metal layers of the PCB.

When designing the PCB layout for optimum thermal performance, we recommend to use a full array of vias under the paddle.

The evaluation board has an exposed solder land pattern with a 4x4 array to which the device is soldered.

This LFCSP package includes two exposed power bars adjacent to the exposed pad at the top and bottom, shown in the datasheet package drawing. These are connected to internal power rails, the area around these is a keep-out zone. Keep these areas clear of traces or vias.

NOTE: RevA hardware layout (files shown below) has the power bars connected to the relevant rail on the board, this was experimental and will not be pursued in future revisions.

EVALUATION BOARD SCHEMATIC AND ARTWORK

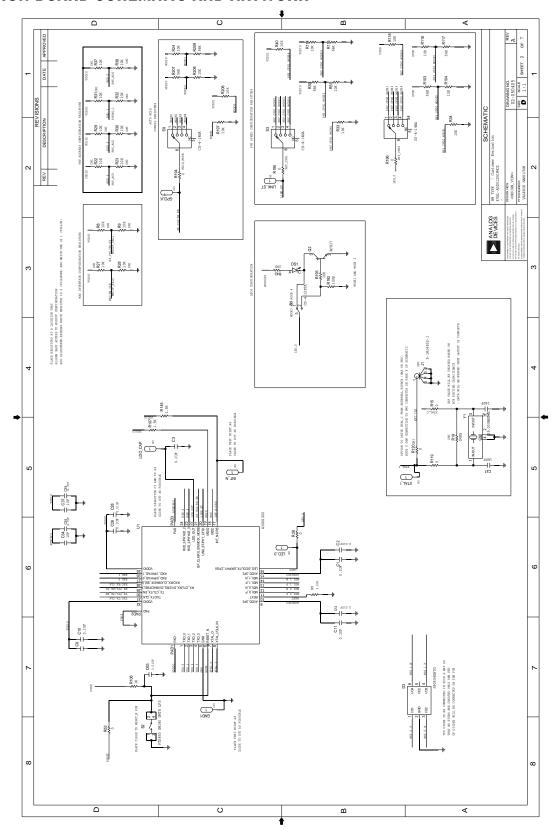


Figure 38. Schematic – page 1.

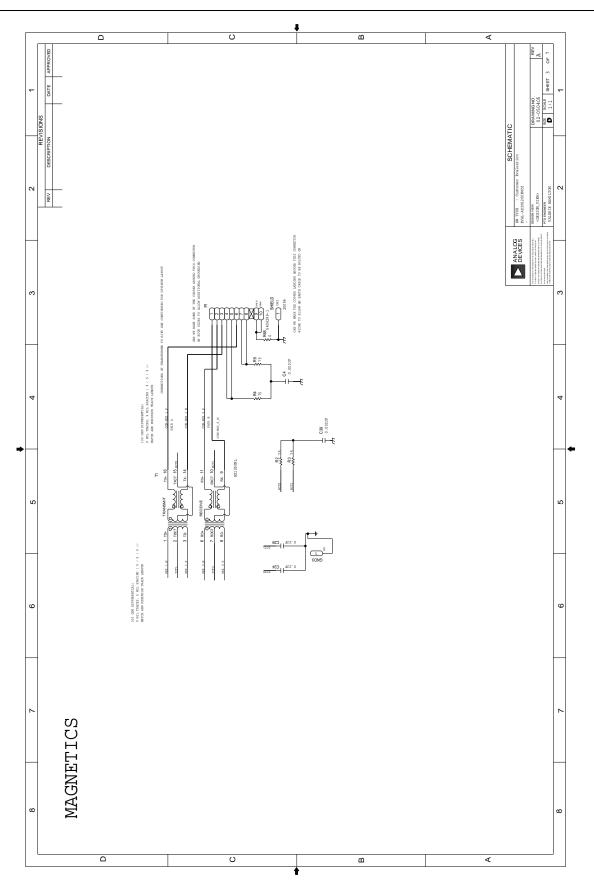


Figure 39. Schematic – page 2.

Rev. PrB | Page 21 of 32

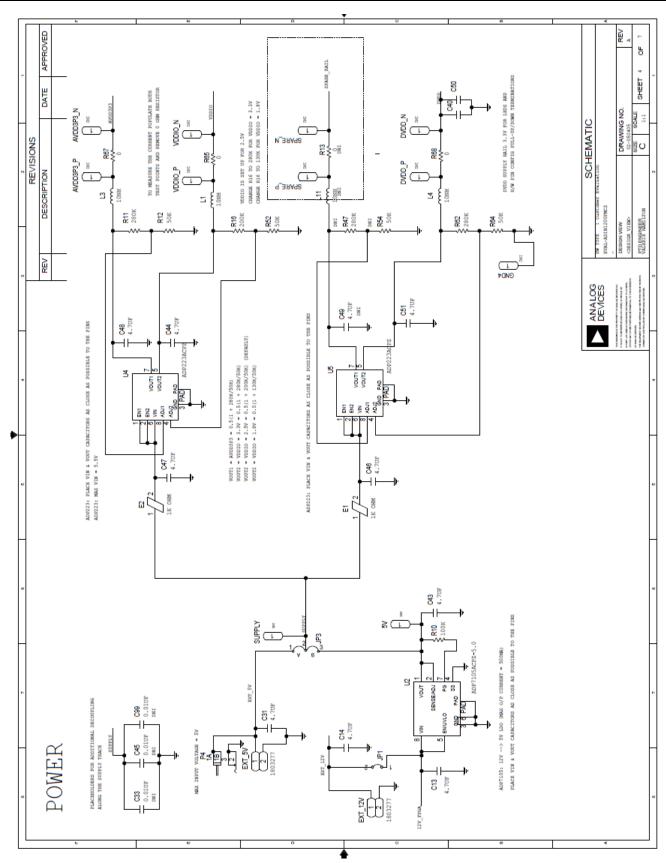


Figure 40. Schematic – page 3.

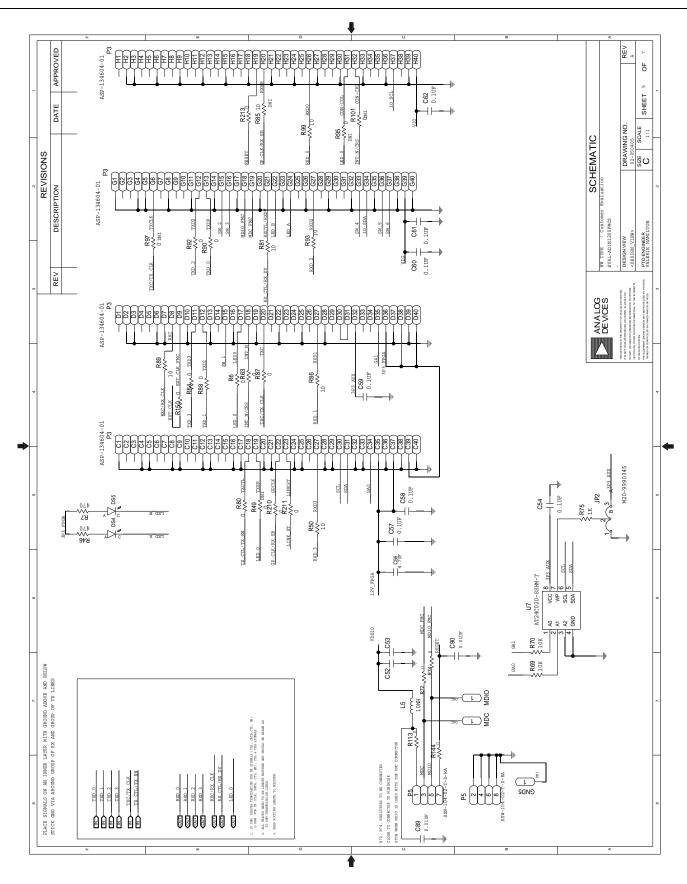


Figure 41. Schematic – page 4.

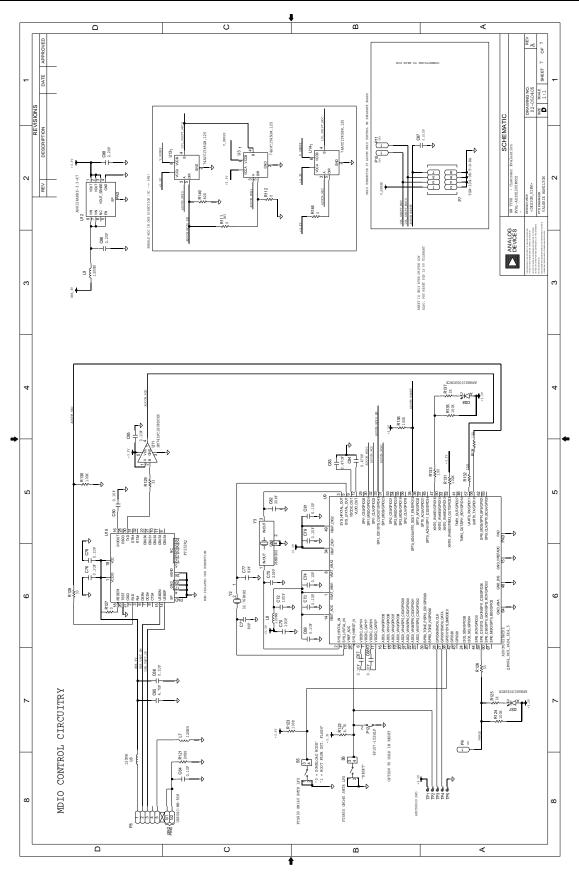


Figure 42. Schematic – page 5.

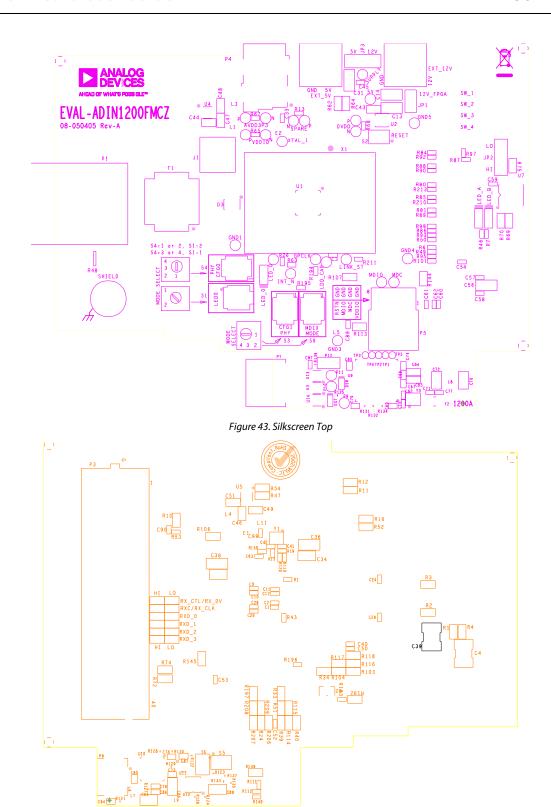


Figure 44. Silkscreen Bottom

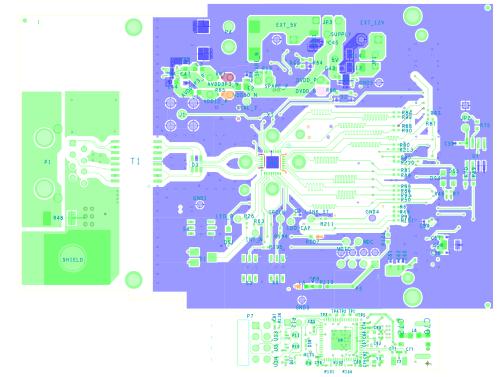


Figure 45. Top PCB Layer

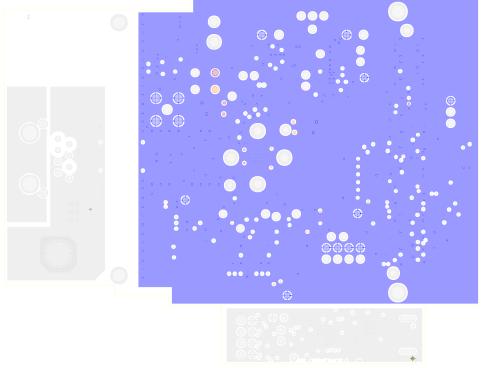


Figure 46.Inner PCB Layer 1 (GND)

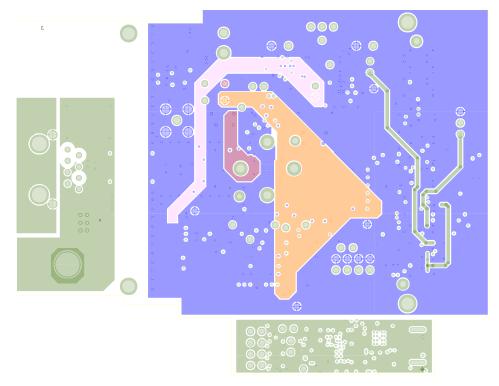


Figure 47. Inner PCB Layer 2(Power)

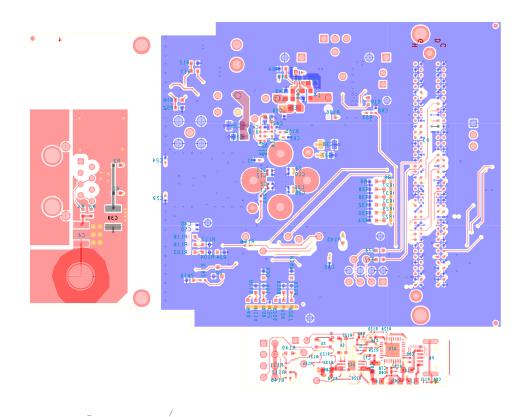


Figure 48. Bottom PCB Layer

ORDERING INFORMATION

BILL OF MATERIALS

Table 6.

Quantity	Reference Designator	Description	Part Number	Supplier
12	C1,C3,C10,C11,C26,C54,C 57,C58,C59,C60,C61,C62	0.1UF, 16V, 10, C0402, CAP CER X7R, BROADBAND	530L104KT16T	AMERICAN TECHNICAL CERAMICS
12	C2,C9,C12,C28,C40,C50,C 52,C53,C63,C87,C89,C90	0.01UF, 25V, 10, C0402, CAP CER X7R, COMMERCIAL GRADE	C1005X7R1E103K050EB	TDK
6	C13,C14,C31,C36,C38,C56	4.7uF, 25V, 10, C1206H71, CAP CER X7R	C1206C475K3RACTU	KEMET
2	C24,C29	0.1UF, 50V, 10, C0402, CAP CER X7R, SOFT TERMINATION	C1005X7R1H104K050BE	TDK
2	C34,C37	1uF, 100V, 10, C0805, CAP CER X7S	C2012X7S2A105K	TDK
2	C4,C39	0.001uF, 3000V, 10, C1812H71, CAP CER X7R, HIGH VOLTAGE	C1812C102KHRACTU	KEMET
2	C41,C42	16pF, 50V, 2, C0402, CAP CER NP0(C0G), HIGH FREQ, HIGH-Q	GJM1555C1H160GB01D	MURATA
6	C43,C44,C46,C47,C48,C51	4.7UF, 10V, 10, C0603H22, CAP CER X6S, GENERAL PURPOSE	GRM185C81A475KE11D	MURATA
13	C64,C66,C67,C68,C69,C73, C74,C76,C78,C79,C80,C81, C85	0.1uF, 50V, 10, C0402H22, CAP CER X7R	CGA2B3X7R1H104K050B	TDK
1	C65	4.7UF, 50V, 10, C0805H53, CAP CER X7R, GENERAL PURPOSE	GRM21BZ71H475KE15L	MURATA
2	C70,C72	10uF, 25V, 10, C0805, CAP CER MULTILAYER X5R, FOR SM-TH COMBO FOOTPRINT USE ALT_SYMBOLS	C2012X5R1E106K085AC	TDK
2	C71,C77	8PF, 16V, 0.5PF, C0402, CAP CER COG	0402YA8R0DAT2A	AVX CORPORATION
2	C75,C82	20PF, 16V, 5, C0402, CAP CER COG	0402YA200JAT2A	AVX CORPORATION
2	C83,C84	0.47uF, 35V, 10, C0603, CAP CER X7R	GMK107B7474KAHT	TAIYO YUDEN
2	C86,C88	2.2uF, 50V, 10, C0805H60, CAP CER X7R	UMK212BB7225KG-T	TAIYO YUDEN
1	D3	SP0504SHTG, 6V, N/A, SOT23_6, DIO TVS ARRAYS, LOW CAP ESD PROTECTION	SP0504SHTG	LITTELFUSE, INC.
3	DS1,DS4,DS5	SML-LX0805SRC-TR, 1.7V, N/A, LED0805_A, LED RED CLEAR, 660NM WAVELENGTH PEAK	SML-LX0805SRC-TR	LUMEX INC.
1	DS7	APHHS1005SECK, 2.1V, N/A, LED0402_A, LED UNI-COLOR ORANGE, 610NM	APHHS1005SECK	KINGBRIGHT ELECTRONIC
1	DS8	APHHS1005SURCK, N/A, N/A, LED0402_A, LED HYPER RED SMD	APHHS1005SURCK	KINGBRIGHT
2	E1,E2	1K OHM, N/A, 25, L0805, IND FERRITE BEAD 1K OHM 0805	BK2125HS102-T	TAIYO YUDEN
2	EXT_5V,EXT_12V	1803277, N/A, N/A, CNHDRRA1X2H285, CONN-PCB HEADER RT 3.81MM	1803277	PHOENIX CONTACT
1	JP1	69157-102HLF, N/A, N/A, CNBERG69157-102, CONN-PCB BERG JMPR ST MALE 2P, 1X M000385	69157-102HLF	AMPHENOL FCI
2	JP2,JP3	M20-9990345, N/A, N/A, CNHDR1X3H340, CONN-PCB 3POS MALE HDR UNSHROUDED SINGLE ROW, 2.54MM PITCH, 3MM SOLDER TAIL	M20-9990345	HARWIN
4	L1,L3,L4,L5	10nH, N/A, 2, L0603, IND HI FREQ WIREWOUND	LQW18AN10NG10D	MURATA MANUFACTURING

Quantity	Reference Designator	Description	Part Number	Supplier
4	L6,L7,L8,L9	120NH, N/A, 25, L0805, IND SM	BLM21BB750SN1B	MURATA MANUFACTURING
1	P1	5406299-1, N/A, N/A, CNTE5406299-1, CONN-PCB MODULAR JASCK ASSEMBLY, SINGLE PORT, O POS, SHIELDED	5406299-1	TE CONNECTIVITY
1	P12	69157-102HLF, N/A, N/A, CNBERG69157-102, CONN-PCB BERG JMPR ST MALE 2P	69157-102HLF	AMPHENOL FCI
1	P3	ASP-134604-01, N/A, N/A, CNSAMTECASP- 134604-01, CONN-PCB SGNL-END ARRAY MALE 160POS, FOR KITT RF APPLICATION USE ALTERNATE SYMBOL	ASP-134604-01	SAMTEC
1	P4	PJ-002AH-SMT-TR, N/A, N/A, CNCUI-PJ- 002A_A, CONN-PCB POWER JACK	PJ-002AH-SMT-TR	CUI
1	P5	SSW-104-02-T-D-RA, N/A, N/A, CNTHFHDRRA2X4L420W335H200, CONN-PCB 8POS SOCKET STRIP DOUBLE ROW RA, 2.54MM PITCH 2.54MM SOLDER TAIL	SSW-104-02-T-D-RA	SAMTEC INC.
1	P7	TSW-104-08-T-D-RA, N/A, N/A, CNHDRRA2X4H240, CONN-PCB HDR RA MALE	TSW-104-08-T-D-RA	SAMTEC
1	P8	UX60SC-MB-5S8, N/A, N/A, CNHRSUX60SC- MB-5S8, CONN-PCB RCPT MINI USB2.0, SHELL TH	UX60SC-MB-5S8	HIROSE ELECTRIC
1	Q2	BC817, 45V, N/A, SOT23-M3, TRAN NPN GEN PURPOSE	BC817	NXP SEMICONDUCTOR S
1	R1	3.01K, N/A, 1, R0402, RES PRECISION THICK FILM CHIP	ERJ-2RKF3011X	PANASONIC
1	R10	100K, N/A, 1, R0603, RES THICK FILM CHIP	CR0603-FX-1003ELF	BOURNS
6	R39,R103,R115,R117,R20 7,R209	56K, N/A, 1, R0603, RES FILM SMD 0603	MC 0.063W 0603 1% 56K.	MULTICOMP (SPC)
14	R24,R33,R34,R40,R51,R69 ,R70,R104,R114,R116,R11 8,R197,R206,R208	10K, N/A, 1, R0603, RES THICK FILM CHIP	MC0063W0603110K	MULTICOMP (SPC)
2	R75,R106	1K, N/A, 1, R0603, RES THICK FILM CHIP	MC0063W060311K	MULTICOMP (SPC)
2	R107,R145	1.5K, 50V, 1, R0603, RES THICK FILM CHIP	MC 0.063W 0603 1% 1K5	MULTICOMP (SPC)
2	R11,R62	280K, N/A, 0.1, R0603, RES METAL FILM HIGH REL	ERA-3AEB2803V	PANASONIC
24	R6,R15,R26,R53,R63,R65, R67,R68,R80,R84,R87,R88 ,R90,R92,R112,R119,R148 ,R150,R194,R195,R196,R2 10,R211,R213	0, 50V, 1, R0402, RES THICK FILM CHIP	MC00625W040210R	MULTICOMP (SPC)
4	R72,R74,R113,R144	0, N/A, 1, R0603, RES FILM SMD 0603	MC0603WG00000T5E- TC	MULTICOMP (SPC)
3	R12,R52,R64	50K, N/A, 0.1, R0603, RES THIN FILM NON- MAGNETIC	PNM0603E5002BST5	VISHAY
1	R121	1MEG, N/A, 1, R0201, RES PRECISION THICK FILM CHIP	ERJ-1GNF1004C	PANASONIC
1	R122	4.7K, 25V, 1, R0201, RES THICK FILM CHIP	MC0201L6F4701SE	MULTICOMP (SPC)
6	R123,R124,R130,R131,R1 35,R136	100K, N/A, 1, R0201, RES PRECISION THICK FILM CHIP	ERJ-1GNF1003C	PANASONIC
2	R125,R137	1K, N/A, 1, R0201, RES PRECISION THICK FILM CHIP	ERJ-1GNF1001C	PANASONIC
3	R126,R128,R129	33, N/A, 1, R0201, RES PREC THICK FILM CHIP	ERJ-1GNF33R0C	PANASONIC

Evaluation Board User Guide

Quantity	Reference Designator	Description	Part Number	Supplier
3	R132,R133,R134	100, N/A, 1, R0201, RES PREC THICK FILM CHIP	ERJ-1GNF1000C	PANASONIC
1	R149	82K, N/A, 1, R0603, RES FILM SMD 0603	MC 0.063W 0603 1% 82K.	MULTICOMP (SPC)
1	R16	200K, N/A, 1, R0603, RES PRECISION THICK FILM CHIP	ERJ-3EKF2003V	PANASONIC
1	R192	100K, N/A, 1, R0603, RES GEN PURPOSE CHIP	RC0603JR-07100KL	YAGEO
1	R193	10K, N/A, 1, R0402, RES PRECISION THICK FILM CHIP	ERJ-2RKF1002X	PANASONIC
4	R2,R3,R4,R5	75, N/A, 1, R0603, RES PRECISION THICK FILM CHIP R0603	ERJ-3EKF75R0V	PANASONIC
1	R43	390, N/A, 5, R0402, RES FILM SMD 0402	ERJ-2GEJ391X	PANASONIC
2	R7,R46	470, N/A, 1, R0402, RES GEN PURPOSE CHIP	RC0402FR-07470RL	YAGEO
1	R48	0, 500V, N/A, R2512, RES THICK FILM CHIP 2512	CRCW25120000Z0EG	VISHAY
6	R50,R81,R86,R89,R93,R99	10, N/A, 1, R0402, RES THICK FILM CHIP	MC00625W0402110R	MULTICOMP (SPC)
1	S1	CS-4-12XTA, N/A, N/A, SWSML197W177H102_3P, SWITCH ROTARY SELECTOR	CS-4-12XTA	NIDEC COPAL ELECTRONICS
3	\$2,\$5,\$6	PTS830 GM140 SMTR LFS, N/A, N/A, SWSML102W120H59, SW TACTILE, MICROMINIATURE TOP ACTUATED, SPST-NO	PTS830 GM140 SMTR LFS	C&K
3	\$3,\$4,\$9	CS-4-14NA, 16V, N/A, SWSML197W177H102_A, SW ROTARY SP4T J- HOOK LEAD	CS-4-14NA	NIDEC COPAL ELECTRONICS
1	T1	HX1260NL, N/A, N/A, TSML500W280H236, TRAN 10/100BASE-T MODULES 1:1 TURNS RATIO	HX1260NL	PULSE ELECTRONICS
1	U1	ADIN1200, N/A, N/A, QFN32_5X5_3PAD, IC- ADI ROBUST, INDUSTRIAL LOW POWER 10/100 GIGABIT ETHERNET PHY, PRELIM	ADIN1200	ANALOG DEVICES
1	U10	FT232RQ, N/A, N/A, QFN32_5X5_PAD3_2X3_2, IC USB SERIAL UART	FT232RQ	FTDI CHIP
1	U11	SN74LVC1G08DCKR, N/A, N/A, SC70-5, IC-TTL SINGLE POSITIVE AND GATE	SN74LVC1G08DCKR	TEXAS INSTRUMENTS
1	U12	ADP124ARHZ-3.3-R7, N/A, N/A, MSOP8_PAD2_16X1_73, IC-ADI CMOS LOW QUIESCENT CURRENT	ADP124ARHZ-3.3-R7	ANALOG DEVICES
3	U3,U13,U14	74AVC1T45GW,125, N/A, N/A, SOT363H43, IC-TTL DUAL SUPPLY TRANSCEIVER, 3 STATE	74AVC1T45GW,125	NXP SEMICONDUCTOR S
1	U2	ADP7105ACPZ-5.0, N/A, N/A, DFN8_3X3_PAD2_38X1_64, IC-ADI 500mA, LOW NOISE LDO REG WITH SOFT START	ADP7105ACPZ-5.0-R7	ANALOG DEVICES
2	U4,U5	ADP223ACPZ, N/A, N/A, QFN8_2X2_PAD1_6X1, IC-ADI ADJ HI PSRR VOLTAGE REGULATOR	ADP223ACPZ-R7	ANALOG DEVICES
1	U7	AT24C02D-SSHM-T, N/A, N/A, SO8, IC I2C COMPATIBLE SERIAL EEPROM 2KBIT	AT24C02D-SSHM-T	ATMEL
1	U9	ADUCM3029BCPZ, N/A, N/A, QFN64_9X9_PAD4_5X4_5, IC-ADI ULTRA LOW PWR ARM CORTEX-M3 MCU	ADUCM3029BCPZ	ANALOG DEVICES
1	X1	32QH50A15050, N/A, N/A, SKTPLA- 32QH50A15050, SKT 32PIN QFN 5X5MM 0.50MM PITCH, HPIN CONTACT	32QH50A15050	PLASTRONICS

Quantity	Reference Designator	Description	Part Number	Supplier
1	Y1	25.000MEGHZ, N/A, 10PPM, YSML79W63H20, IC CRYSTAL, 10PF LOAD CAP	FA- 128_25.000000MHZ_10. 0_+10-10	SEIKO EPSON
1	Y2	32.768KHZ, N/A, 20PPM, YSML126W59H35, IC CRYSTAL TUNING FORK, 6PF LOAD CAP	ABS07-120-32.768KHZ-T	ABRACON CORP.
1	Y3	26MEGHZ, N/A, 30PPM, YSML98W79H24, IC CRYSTAL, 10PF LOAD CAP	ECS-260-10-36Q-ES-TR	ECS, INC.

The following components are part of the PCB but are NOT populated:

Quantity	Reference Designator	Description	Part Number	Supplier
25	5V,AVDD3P3_N,AVDD3P3_P,DVD D_N,DVDD_P,GND1,GND3,GND4, GND5,GPCLK,INT_N,LDO_CAP,LE D_0,LINK_ST,MDC,MDIO,P9,P10, P11,SPARE_N,SPARE_P,SUPPLY,V DDIO_N,VDDIO_P,XTAL_I	1405-2, N/A, N/A, CNKEY1405-2, CONN-PCB MICRO PIN	1405-2	KEYSTONE ELECTRONICS
3	C33,C45,C99	0.01UF, 25V, 10, C0402, CAP CER X7R, COMMERCIAL GRADE	C1005X7R1E103K050EB	TDK
1	C49	4.7UF, 10V, 10, C0603H22, CAP CER X6S, GENERAL PURPOSE	GRM185C81A475KE11D	MURATA
1	J1	5-1814832-1, N/A, N/A, CNTYCO1814832, CONN-PCB STRAIGHT SMA PCB DIE CAST	5-1814832-1	TE CONNECTIVITY LTD
1	L11	10nH, N/A, 2, L0603, IND HI FREQ WIREWOUND	LQW18AN10NG10D	MURATA MANUFACTURI NG
7	R13,R49,R95,R97,R101,R111,R120	0, 50V, 1, R0402, RES THICK FILM CHIP	MC00625W040210R	MULTICOMP (SPC)
1	R19	1MEG, N/A, 1, R0402, RES PRECISION THICK FILM CHIP	ERJ-2RKF1004X	PANASONIC
12	R8,R9,R22,R23,R27,R28,R29,R30,R 31,R32,R37,R38	10K, N/A, 1, R0603, RES THICK FILM CHIP	MC0063W0603110K	MULTICOMP (SPC)
1	R47	280K, N/A, 0.1, R0603, RES METAL FILM HIGH REL	ERA-3AEB2803V	PANASONIC
1	R54	50K, N/A, 0.1, R0603, RES THIN FILM NON-MAGNETIC	PNM0603E5002BST5	VISHAY
1	R85	10, N/A, 1, R0402, RES THICK FILM CHIP	MC00625W0402110R	MULTICOMP (SPC)

Evaluation Board User Guide

NOTES



ESD Caution

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

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